Product data sheet

1. General description

Ultrafast, epitaxial rectifier diode in a SOD59 (TO-220AC) plastic package.

2. Features and benefits

- Fast switching
- · Low thermal resistance
- · Low forward voltage drop
- · Soft recovery characteristic
- · High thermal cycling performance

3. Applications

- Discontinuous Current Mode (DCM) Power Factor Correction (PFC)
- · High frequency switched-mode power supplies

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values			Unit	
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage		600			V	
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; $T_{mb} \le 120 ^{\circ}\text{C}$			9		Α
I _{FRM}	repetitive peak forward current	δ = 0.5; $T_{mb} \le$ 120 °C; square-wave pulse	18		А		
I _{FSM}	non-repetitive peak	t _p = 10 ms; sine-wave pulse		-	70)	
	forward current	= 8.3 ms; sine-wave pulse 77			А		
Symbol	Parameter	Conditions	Min Typ Max		Unit		
Static ch	aracteristics						
V _F	forward voltage	I _F = 8 A; T _j = 25 °C		-	1.12	1.25	V
		I _F = 8 A; T _j = 150 °C; <u>Fig. 2</u>		-	0.97	1.11	V
		I _F = 20 A; T _j = 25 °C; <u>Fig. 2</u>		-	1.31	1.45	V
Dynamic	characteristics				1		1
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 3$		-	50	60	ns

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BYV29-600

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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	
2	А	anode]	K — A 001aaa020
mb	mb	mounting base; cathode	1 2 TO-220AC (SOD59)	001aaa020

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BYV29-600	TO-220AC	plastic single-ended package; heatsink mounted; 1 mounting hole; 2-lead TO-220AC	SOD59		

7. Marking

Table 4. Marking codes

Type number	Marking codes
BYV29-600	BYV29-600

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		600	V
V_{RWM}	crest working reverse voltage		600	V
V_R	reverse voltage	δ = 1.0; square-wave pulse; T _{mb} ≤ 100 °C	600	V
I _{F(AV)}	average forward current	δ = 0.5; square-wave pulse; T _{mb} ≤ 120 °C	9	Α
I _{FRM}	repetitive peak forward current	δ = 0.5; T _{mb} ≤ 120 °C; square-wave pulse	18	А
I _{FSM}	non-repetitive peak	t _p = 10 ms; sine-wave pulse	70	А
	forward current	t _p = 8.3 ms; sine-wave pulse	77	Α
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		150	°C

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9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	with heatsink compound; Fig 1	-	-	2.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W

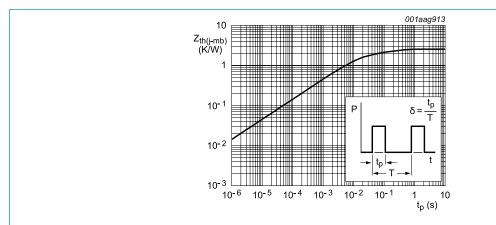


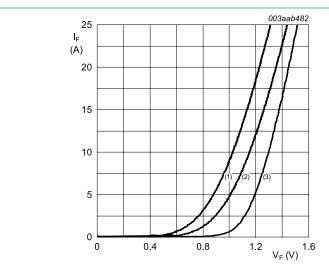
Fig. 1. Transient thermal impedance from junction to mounting base as a function of pulse width

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10. Characteristics

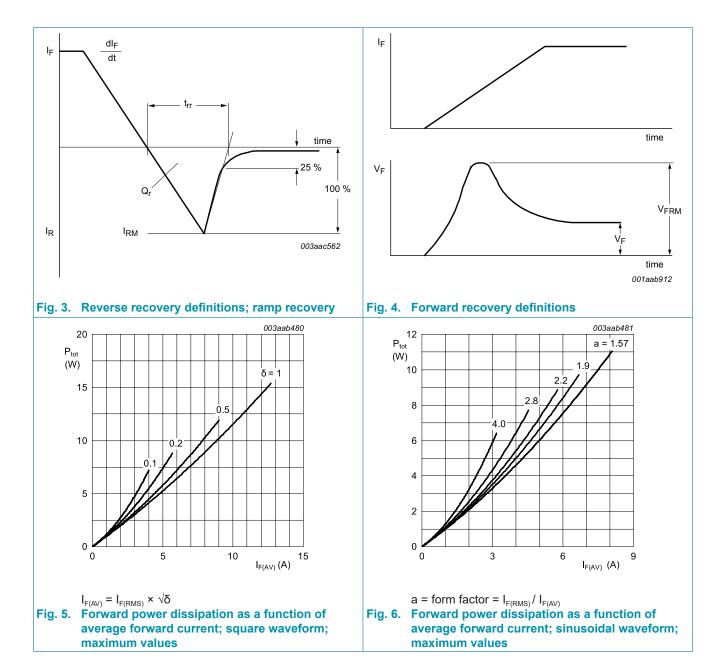
Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _F	forward voltage	I _F = 20A; T _j = 25 °C; <u>Fig. 2</u>	-	1.31	1.45	V
		I _F = 8 A; T _j = 25 °C	-	1.12	1.25	V
		I _F = 8 A; T _j = 150 °C; <u>Fig. 2</u>	-	0.97	1.11	V
I _R	reverse current	V _R = 600 V; T _j = 25 °C	-	2	50	μA
		V _R = 600 V; T _j = 100 °C	-	0.1	0.35	mA
Dynamic	characteristics					
Q_r	recovered charge	$I_F = 2 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 20 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 3$	-	40	70	nC
t _{rr}	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 3$	-	50	60	ns
I _{RM}	peak reverse recovery current	$I_F = 10 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 50 \text{ A/}\mu\text{s};$ $T_j = 100 \text{ °C}; Fig. 3$	-	3	5.5	А
V_{FR}	forward recovery voltage	$I_F = 10 \text{ A}$; $dI_F/dt = 10 \text{ A/}\mu\text{s}$; $T_j = 25 \text{ °C}$; Fig. 4	-	3.2	-	V

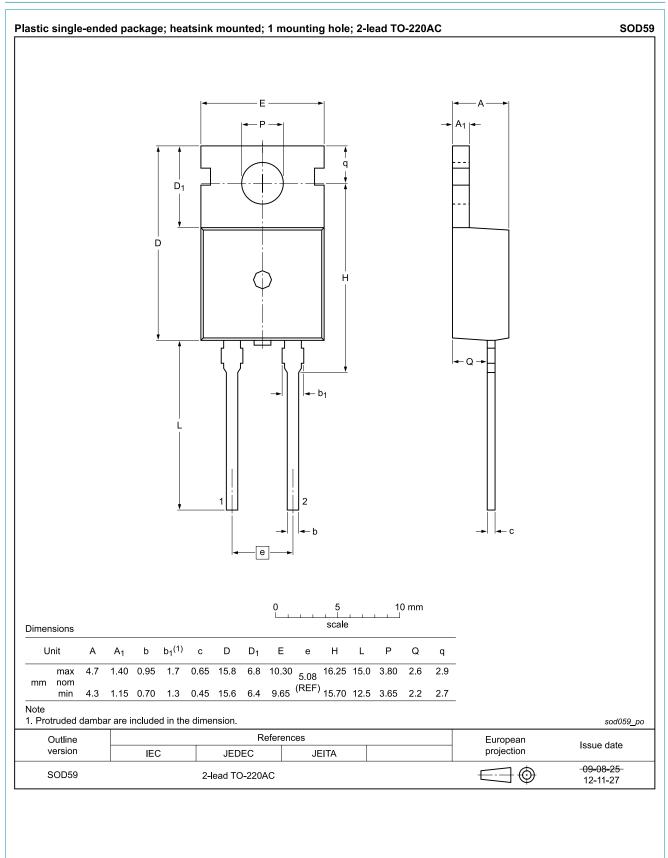


(1) T_j = 150 °C; typical values (2) T_j = 150 °C; maximum values (3) T_j = 25 °C; maximum values Fig. 2. Forward current as a function of forward voltage

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11. Package outline



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12. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
BYC29-600 v.3	20180307	Product data sheet	-	BYV29-600_2			
Modifications:	Change from NXP version to WeEn version						
BYV29-600_2	20071024	Product data sheet	-	BYV29-600_1			
• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. • Legal texts have been adapted to the new company name where appropriate. • Table 5 "Characteristics" on page 3: VF values updated.							
BYV29-600_1	20000201	Product specification	-	-			

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13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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